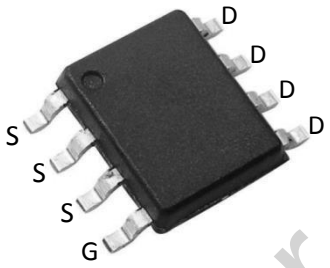
Description：

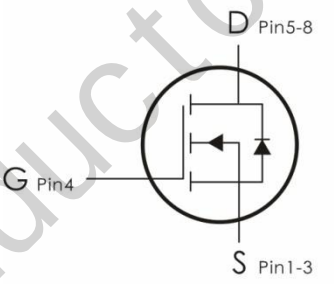
This N-Channel MOSFET uses advanced trench technology and design to provide excellent $R_{DS(on)}$ with low gate charge.

It can be used in a wide variety of applications.



Features：

1) V_{DS}=30V,I_D=11A,$R_{DS(ON)}$<10mΩ @V_{GS}=10V
2) Low gate charge.
3) Green device available.
4) Advanced high cell denity trench technology for ultra low $R_{DS(ON)}$
5) Excellent package for good heat dissipation.



Absolute Maximum Ratings： (T_A=25℃ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Drain Current – Continuous (T_A=25℃)[1]	11	A
	Drain Current – Continuous (T_A=100℃)[1]	7	
I_{DM}	Drain Current – Pulsed[2]	36	
E_{AS}	Single Pulse Avalanche Energy[3]	24.2	mj
I_{AS}	Avalanche Current	22	A
P_D	Power Dissipation (T_A=25℃)[4]	1.5	W
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	℃

Thermal Characteristics：

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Thermal Resistance,Junction to Case[1]	25	℃/W
$R_{\theta JA}$	Thermal Resistance,Junction to Ambient[1]	85	

Electrical Characteristics: (T_A=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Sourtce Breakdown Voltage	V_{GS}=0V,I_D=250μA	30	---	---	V
I_{DSS}	Drain-Source Leakage Current	V_{DS}=150V , V_{GS}=0V	---	---	1	uA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V, V_{DS}=0V	---	---	±100	nA
On Characteristics[3]						
$V_{GS(th)}$	GATE-Source Threshold Voltage	V_{GS}=V_{DS}, I_D=250μA	1.2	1.5	2.5	V
$R_{DS(ON)}$	Static Drain-Source On Resistance[2]	V_{GS}=10V,I_D=8A	---	9	10	mΩ
		V_{GS}=4.5V,I_D=6A	---	12	18	
G_{FS}	Forward Transconductance	V_{DS}=5V, I_D=8A	---	24	---	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS}=15V, V_{GS}=0V, f=1MHz	---	940	1316	pF
C_{oss}	Output Capacitance		---	131	183	
C_{rss}	Reverse Transfer Capacitance		---	109	153	
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DS}=15V, , R_{GEN}=1.5Ω , V_{GS}=10V I_D=8A	---	4.2	8.4	ns
t_r	Rise Time		---	8.2	15	ns
$t_{d(off)}$	Turn-Off Delay Time		---	31	62	ns
t_f	Fall Time		---	4	8	ns
Q_g	Total Gate Charge	V_{GS}=4.5V, V_{DS}=15V, I_D=8A	---	9.63	13.5	nC
Q_{gs}	Gate-Source Charge		---	3.88	5.4	nC
Q_{gd}	Gate-Drain “Miller” Charge		---	3.44	4.8	nC
Drain-Source Diode Characteristics						
V_{SD}	Source-Drain Diode Forward Voltage[2]	V_{GS}=0V,I_S=1A,T_J=25℃	---	---	1	V

I_S	Continuous Source Current[1,5]	$V_G=V_D=0V$, Force Current	---	---	9	A
I_{SM}	Pulsed Source Current[2,5]		---	---	36	
Trr	Body Diode Reverse Recovery Time	I_F=8A , dI/dt=100A/μs , T_J=25℃	---	8	---	Ns
Qrr	Body Diode Reverse Recovery Charge		---	2.9	---	Nc

Notes:

1. The data tested by surface mounted on a 1 inch^2 FR-4 board with 2OZ copper.
2. The data tested by pulsed , pulse width ≦ 300us , duty cycle ≦ 2%
3. The EAS data shows Max. rating . The test condition is V_{DD}=25V,V_{GS}=10V,L=0.1mH,I_{AS}=22A
4. The power dissipation is limited by 150℃ junction temperature
5. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics:

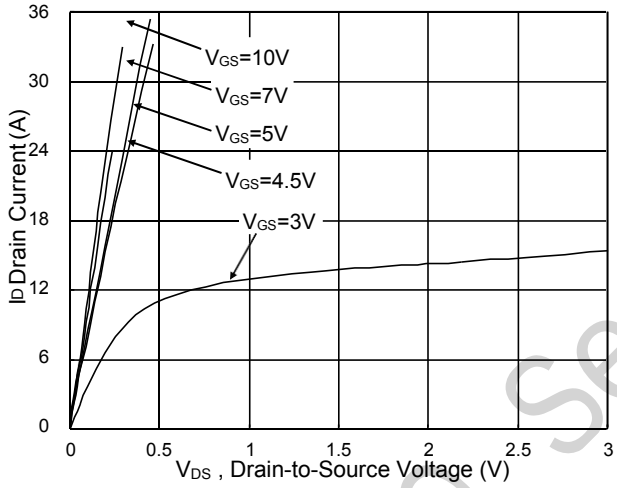


Fig.1 Typical Output Characteristics

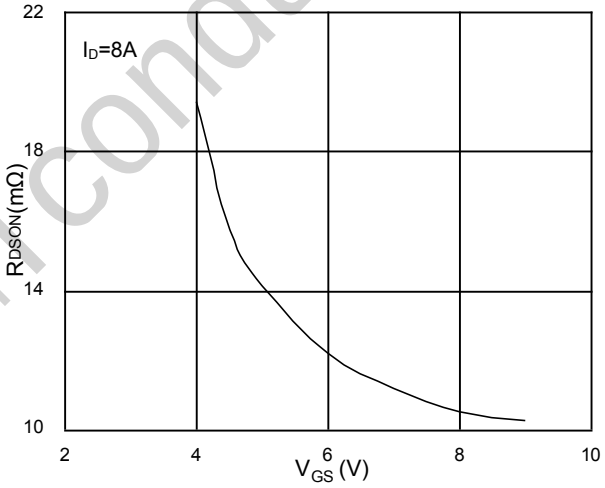
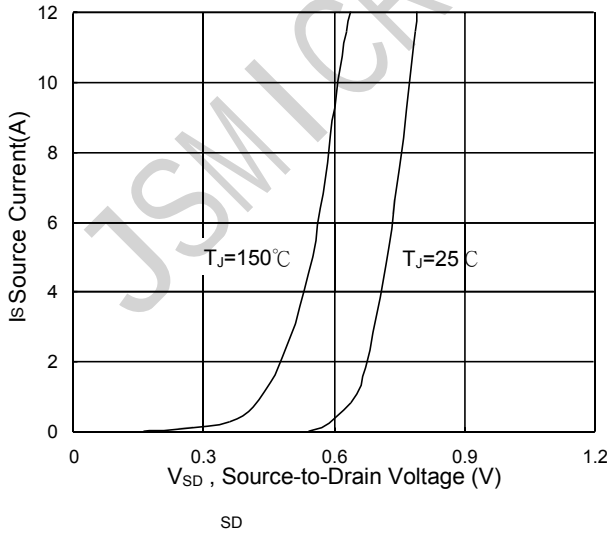


Fig.2 On-Resistance vs. G-S Voltage



SD

Fig.3 Forward Characteristics of Reverse

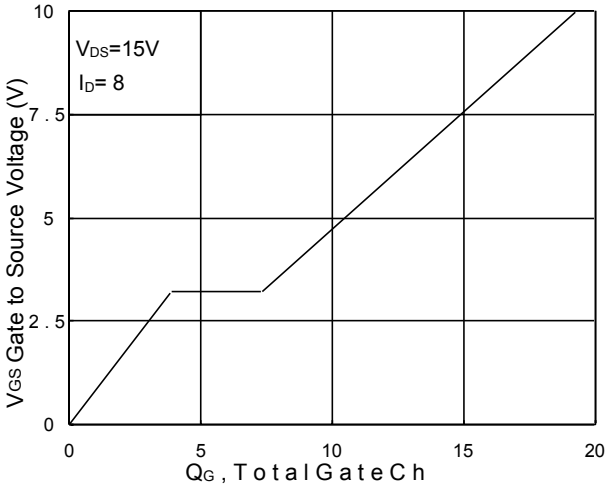


Fig.4 Gate-Charge Characteristics

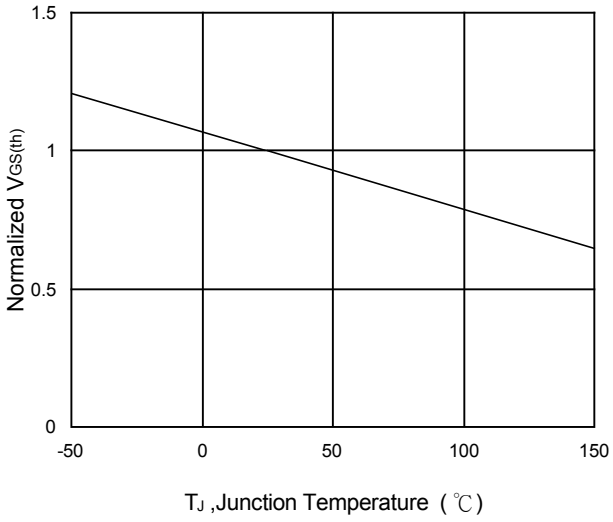


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

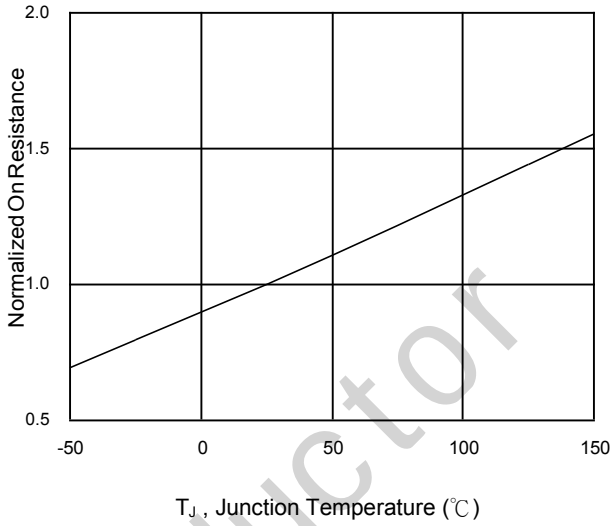


Fig.6 Normalized R_{DSON} vs. T_J

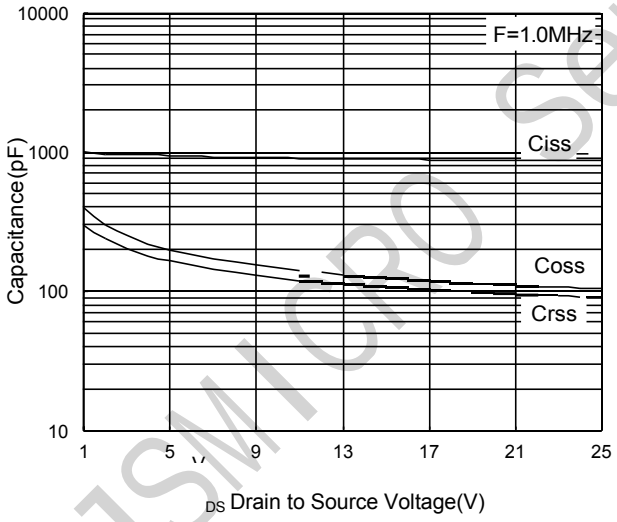


Fig.7 Capacitance

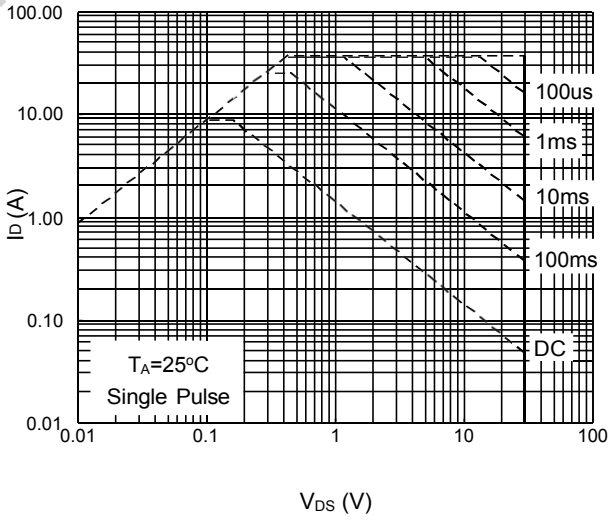


Fig.8 Safe Operating Area

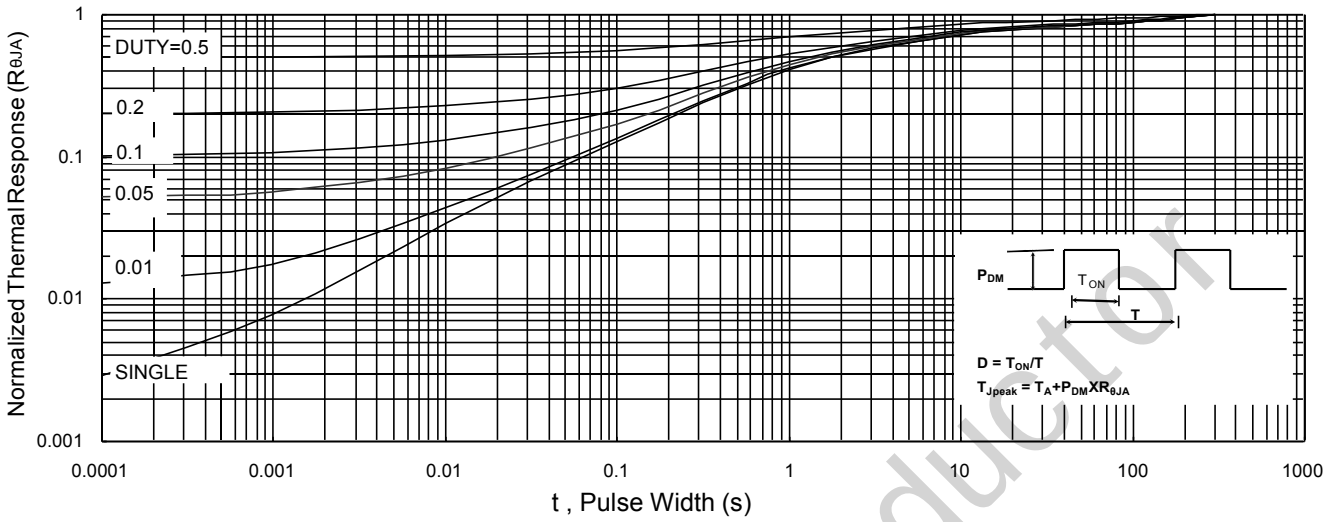
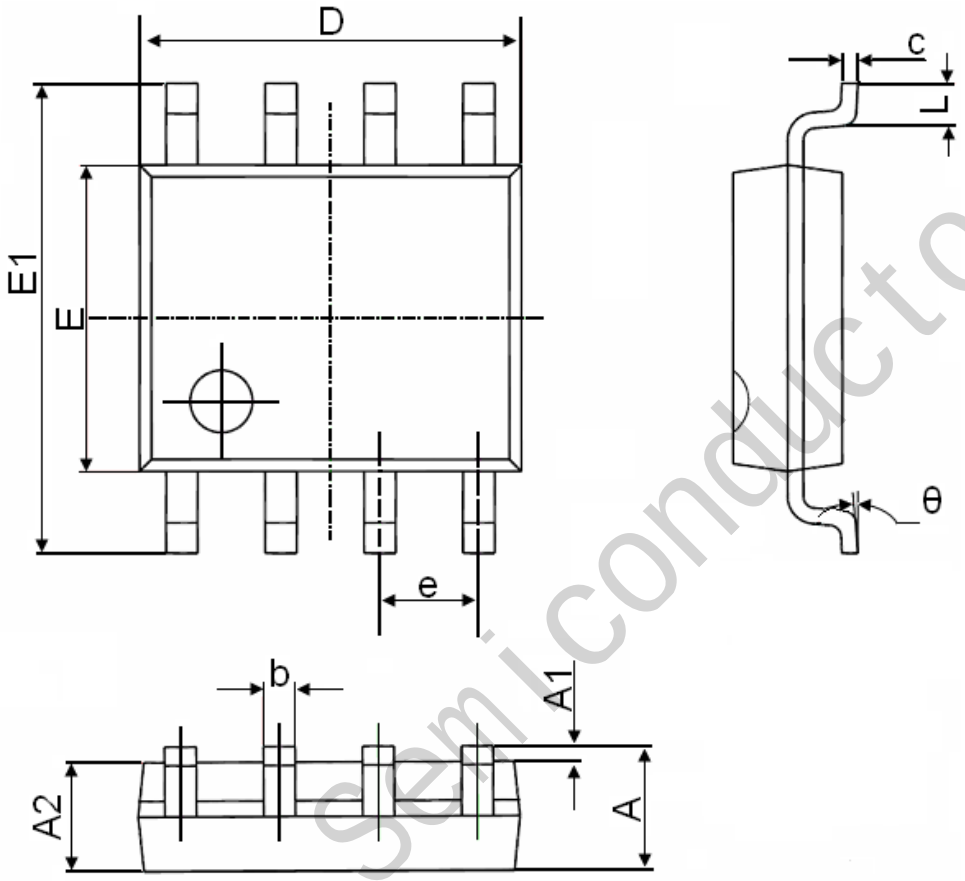


Fig.9 Normalized Maximum Transient Thermal Impedance

SOP-8 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

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